SiHH21N60E

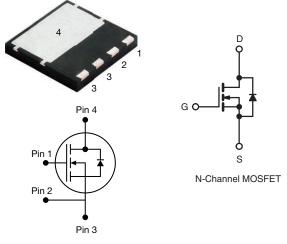
Vishay Siliconix



E Series Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.153			
Q _g max. (nC)	83				
Q _{gs} (nC)	11				
Q _{gd} (nC)	20				
Configuration	Single				

PowerPAK[®] 8 x 8



FEATURES

- Fully lead (Pb)-free device
- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8
Lead (Pb)-free and Halogen-free	SiHH21N60E-T1-GE3

ABSOLUTE MAXIMUM RATINGS	T _C = 25 °C, unless otherwis	se noted)		
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V _{DS}	600	v
Gate-Source Voltage		V _{GS}	± 30	v
Continuous Drain Current (T _J = 150 °C)	$V_{GS} \text{ at 10 V} \qquad \frac{T_C = 25 \text{ °C}}{T_C = 100 \text{ °C}}$	Ι _D	20	
	$T_{\rm C} = 100 ^{\circ}{\rm C}$		12	A
Pulsed Drain Current ^a			48	
Linear Derating Factor			1.4	W/°C
Single Pulse Avalanche Energy ^b	E		226	mJ
Maximum Power Dissipation		PD	104	W
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope	T _J = 125 °C	d\//dt	70	1//20
Reverse Diode dV/dt ^c		dV/dt	29	V/ns

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

- b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 4 A.
- c. $I_{SD} \leq I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C.

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For technical questions, contact: hvm@vishav.com

Document Number: 91584



COMPLIANT HALOGEN

www.vishay.com

SiHH21N60E

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R _{thJA}	40		52			°C / M	
Maximum Junction-to-Case (Drain)	R _{thJC}	0.55	0.72			°C/W		
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, u	Inless otherwi	se noted)						
PARAMETER	SYMBOL	1	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static		1			1			1
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 μA	600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I _D = 1 mA	-	0.64	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	V_{GS} , $I_D = 2$	250 µA	2	-	4	V
Osta Osuma Laskasa		١	$V_{\rm GS} = \pm 20$	V	-	-	± 100	nA
Gate-Source Leakage	I _{GSS}	١	$V_{\rm GS} = \pm 30$	V	-	-	± 1	μA
Zene Osta Vieltana Dusia Ormant		V _{DS} =	600 V, V _G	_S = 0 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 480 V	, V _{GS} = 0 V	, T _J = 125 °C	-	-	50	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	١ _D	₀ = 11 A	-	0.153	0.176	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	= 30 V, I _D =	: 11 A	-	8.1	-	S
Dynamic								
Input Capacitance	C _{iss}		$V_{GS} = 0 V,$		-	2015	-	
Output Capacitance	C _{oss}	$V_{\rm GS} = 100 \text{ V},$ $V_{\rm DS} = 100 \text{ V},$ f = 1 MHz		-	93	-	pF	
Reverse Transfer Capacitance	C _{rss}			-	6	-		
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	$V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V		-	60	-		
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	254	-		
Total Gate Charge	Qg				-	55	83	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	I _D = 11 A	A, V _{DS} = 480 V	-	11	-	nC
Gate-Drain Charge	Q _{gd}				-	20	-	
Turn-On Delay Time	t _{d(on)}				-	20	40	
Rise Time	t _r	V _{DD} = 480 V, I _D = 11 A,		-	32	68	ns	
Turn-Off Delay Time	t _{d(off)}	V _{GS} =	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	68	102	115
Fall Time	t _f			-	45	90		
Gate Input Resistance	R _g	f = 1 MHz, open drain		0.3	0.6	1.3	Ω	
Drain-Source Body Diode Characteristic	cs							
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	20	A	
Pulsed Diode Forward Current	I _{SM}				-	-	48	
Pulsed Diode Forward Current Diode Forward Voltage	I _{SM} V _{SD}	p - n junction	diode	$V_{GS} = 0 V$	-	- 0.9	48 1.2	V
		p - n junction $T_J = 25 \text{ °C}$	diode C, I _S = 11 A					V ns
Diode Forward Voltage	V _{SD}	p - n junction $T_J = 25 \text{ °C}$ $T_J = 25 \text{ °C}$	diode	= 11 A,	-	0.9	1.2	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

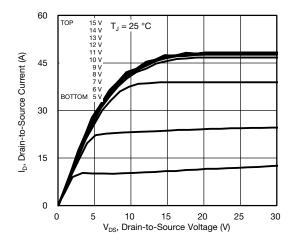
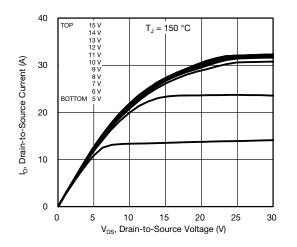
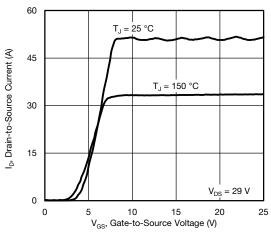


Fig. 1 - Typical Output Characteristics





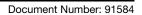




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3 For technical questions, contact: <u>hvm@vishay.com</u>

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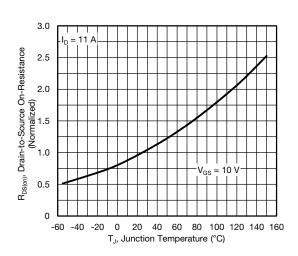


Fig. 4 - Normalized On-Resistance vs. Temperature

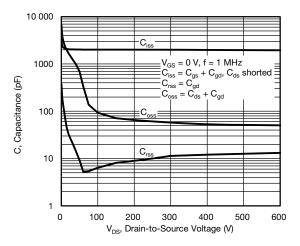
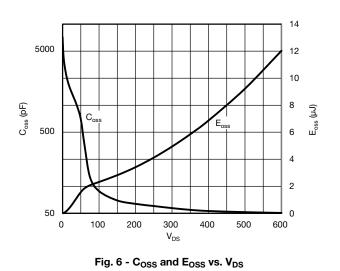


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





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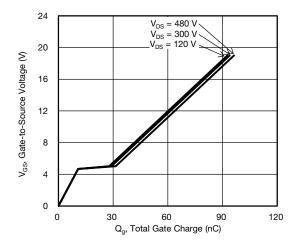


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

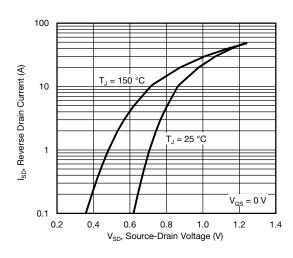


Fig. 8 - Typical Source-Drain Diode Forward Voltage

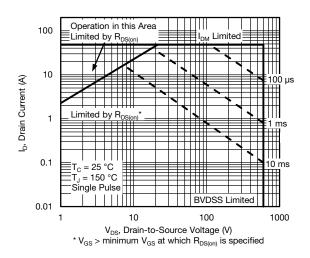


Fig. 9 - Maximum Safe Operating Area

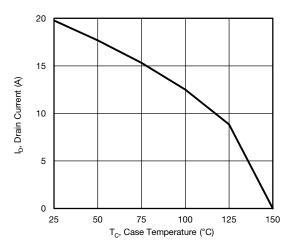


Fig. 10 - Maximum Drain Current vs. Case Temperature

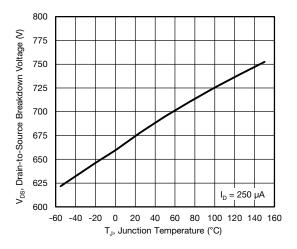
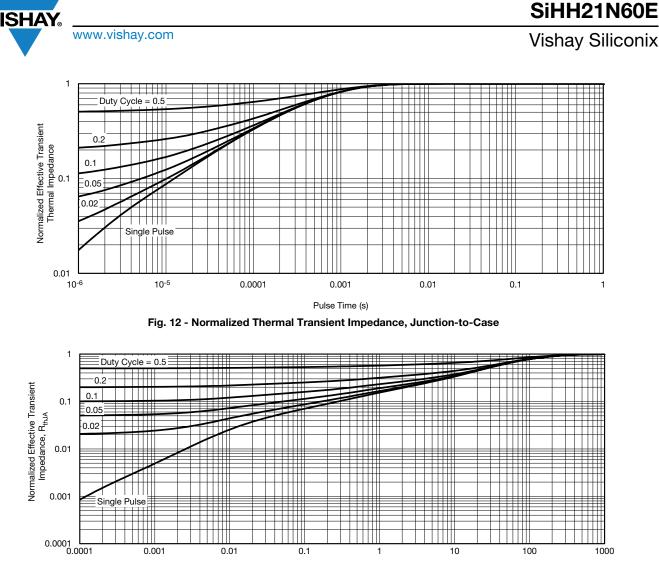


Fig. 11 - Temperature vs. Drain-to-Source Voltage



Pulse Time (s)

Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

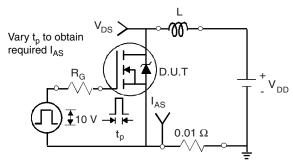


Fig. 14 - Switching Time Test Circuit

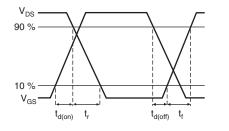


Fig. 15 - Switching Time Waveforms

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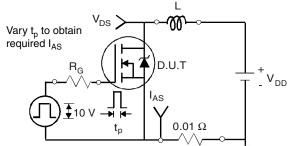


Fig. 16 - Unclamped Inductive Test Circuit

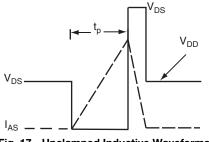
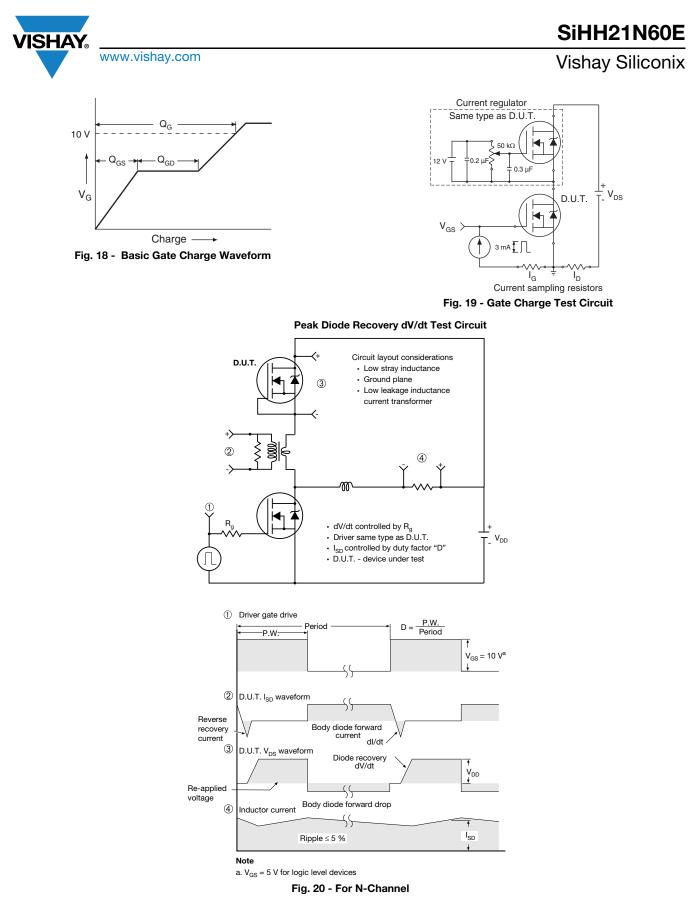


Fig. 17 - Unclamped Inductive Waveforms

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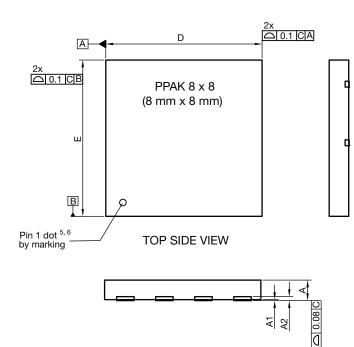
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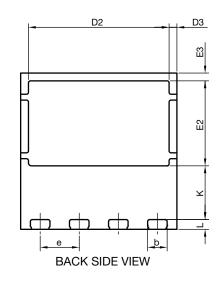
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PowerPAK[®] 8 x 8 Case Outline





DIM	MILL				INCHES				
DIM.	DIM. MIN.	NOM.	MAX.	MIN.	NOM.	MAX.			
А	0.95	1.00	1.05	0.037	0.039	0.041			
A1	0.00	-	0.05	0.000	-	0.002			
A2		020 ref.			0.008 ref.				
b	0.95	1.00	1.05	0.037	0.039	0.041			
D	7.90	8.00	8.10	0.311	0.315	0.319			
D2	7.10	7.20	7.30	0.280	0.283	0.287			
D3		0.40 BSC		0.016 BSC			0.016 BSC		
е		2.00 BSC		0.079 BSC					
E	7.90	8.00	8.10	0.311	0.315	0.319			
E2	4.30	4.35	4.40	0.169	0.171	0.173			
E3		0.40 BSC		0.016 BSC					
К	2.75 BSC		0.108 BSC						
L	0.45	0.50	0.55	0.018	0.020	0.022			
N ⁽³⁾	8			8					

Notes

⁽¹⁾ Use millimeters as the primary measurement

⁽²⁾ Dimensioning and tolerances conform to ASME Y14.5 M - 1994

⁽³⁾ N is the number of terminals

⁽⁴⁾ The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body

⁽⁵⁾ Exact shape and size of this feature is optional

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Revision: 28-Sep-2020

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Recommended Minimum PADs for PowerPAK[®] 8 mm x 8 mm



Dimensions in millimeters

Document Number: 68441



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